

JIEJIE MICROELECTRONICS CO., Ltd

J20GxxxM2SH Gas Discharge Tube

Rev.1.0

FEATURE

- ♦ Eliminates small size design EIA 8.3×8.3×6.0mm.
- → Current handling capability 20,000A@8/20µs.
- ♦ Low capacitance and insertion loss.
- → Fast response and long service life.
- ♦ Reliable to protect electrostatic surge.
- ♦ Moisture sensitivity level: Level 1.



Exterior



APPLICATION INFORMATION

Schematic symbol

- ♦ Repeaters, modems.
- → Telephone interface, line cards.
- ♦ Data communication equipment.
- Line test equipment.

ELECTRICAL CHARACTERISTICS

| Part number | DC breakdown Tolerance | Impulse spark-over | Impulse discharge | Insulation resistance | | Co | |
|-------------|---------------------------|-----------------------|----------------------|-----------------------|----|-------|--------|
| | voltage 100V/s(V) | of V _S | voltage 1KV/µs(V) | current 8/20µs(A) | GΩ | DC(V) | (1MHz) |
| J20G091M2SH | 90 | ±20% | ≤700 | 20,000 | ≥1 | 100 | ≤1.5pF |
| J20G231M2SH | 150 | ±20% | ≤900 | 20,000 | ≥1 | 100 | ≤1.5pF |
| J20G471M2SH | 470 | ±20% | ≤1100 | 20,000 | ≥1 | 100 | ≤1.5pF |
| J20G601M2SH | 600 | ±20% | ≤1300 | 20,000 | ≥1 | 100 | ≤1.5pF |

- 1. The parameters of all tested by ITU-T K12.
- 2. Total Impulse discharge current 20,000A@ 8/20µs by IEC 61000-4-5, 10 shots.
- 3. The capacitance is tested by 1MHz@DC=0.5V.
- 4. The V-T waveform of DCBV and IPBV mus lie between the shades.

PART NUMBERING SYSTEM

<u>J20G</u> <u>231</u> <u>M</u> <u>2S</u> <u>H</u> (1) (2) (3) (4) (5)

(1)JieJie 20KA gas discharge tube

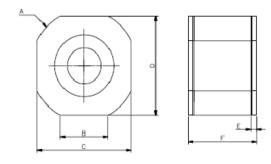
(2) DC breakdown voltage, e.g., $231=23\times10^{1}=230\text{V}$

(3) Tolerance is DC breakdown voltage, M=+-20%, N=+-30%

(4) 2-electrod SMD

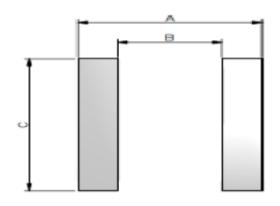
(5) Dimension in $8.3 \times 8.3 \times 6.0$ (mm)

PRODUCT DIMENSIONS (unit: mm)



| REF | mm | inch |
|-----|----------|--------------|
| A | Φ9.3±0.1 | Ф0.366±0.004 |
| В | 4.2±0.1 | 0.165±0.004 |
| С | 8.3±0.2 | 0.327±0.008 |
| D | 8.3±0.2 | 0.327±0.008 |
| Е | 0.5±0.05 | 0.02±0.002 |
| F | 6±0.2 | 0.236±0.008 |

RECOMMENDED SOLDERING PAD

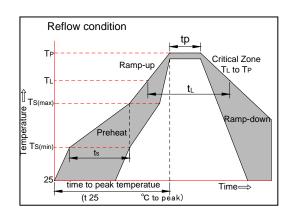


| REF | mm | inch |
|-----|------|-------|
| A | 7.95 | 0.313 |
| В | 4.5 | 0.177 |
| С | 8 | 0.315 |

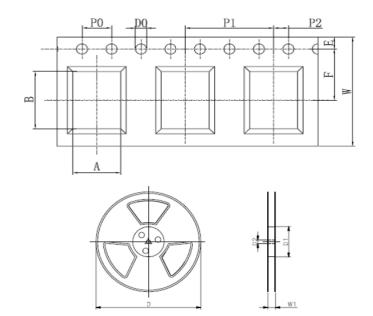


REFLOW PROFILE

| 1 | | | |
|--|---|-----------------------|--|
| Reflow Condition | | Pb-Free assembly | |
| | | (see figure at right) | |
| Pre Heat | -Temperature Min (T _{s(min)}) | +150℃ | |
| | -Temperature Max(T _{s(max)}) | +200℃ | |
| | -Time (Min to Max) (ts) | 60-180 secs. | |
| Average ramp up rate (Liquidus Temp | | 3℃/sec. Max | |
| (T _L)to peak) | | | |
| $T_{s(max)}$ to T_L - Ramp-up Rate | | 3°C/sec. Max | |
| Reflow | -Temperature(T _L)(Liquidus) | +217 ℃ | |
| | -Temperature(t _L) | 60-150 secs. | |
| Peak Temp (T _p) | | +260(+0/-5)°C | |
| Time within 5°Cof actual Peak Temp (t _p) | | ~10 secs. | |
| Ramp-do | wn Rate | 6°C/sec. Max | |
| Time 25° | to Peak Temp (T _P) | 8 min. Max | |
| Do not exceed | | +260 ℃ | |



PACKAGE REEL INFORMATION



| REF | mm | inch |
|-----|------------------------------------|--------------------------|
| P0 | 4.0±0.1 | 0.157±0.004 |
| D0 | Φ1.5 ^{+0.1} ₋₀ | Φ0.059 ^{+0.004} |
| P1 | 12±0.1 | 0.472±0.004 |
| P2 | 2.0±0.1 | 0.079±0.004 |
| A | 6.5±0.2 | 0.256 ± 0.008 |
| В | 8.4±0.2 | 0.331 ± 0.008 |
| F | 7.5±0.1 | 0.295±0.004 |
| E | 1.75±0.1 | 0.069±0.004 |
| W | 16±0.3 | 0.63±0.012 |
| D | Ф330±2 | Φ12.99±0.079 |
| D1 | Φ100±2 | Ф3.94±0.079 |
| D2 | Φ13±0.15 | 0.512±0.006 |
| W1 | 21±2 | 0.827±0.079 |



PACKAGING

| Part No. | Reel Quantity (pcs) | Per Carton (pcs) |
|-------------|---------------------|------------------|
| J20GxxxM2SH | 500 | 10,000 |

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